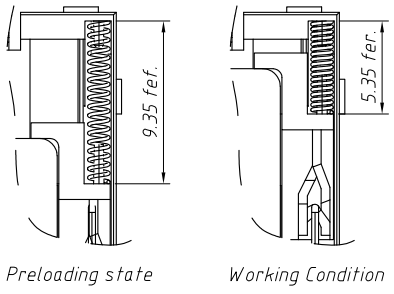
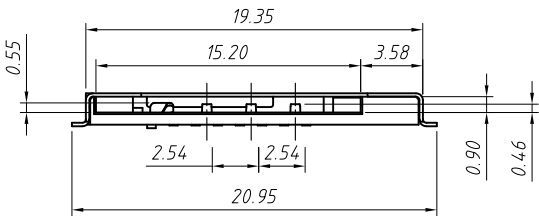


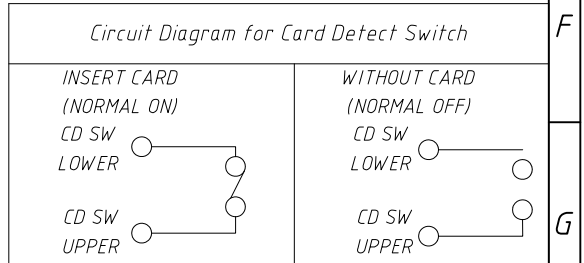


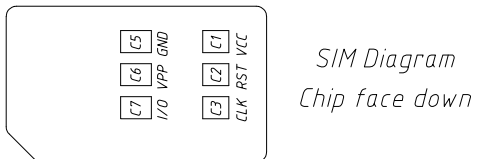
Pin No.	Description
P1 #	C1:VCC
P2 #	C5:GND
P3 #	C2:RST
P4 #	C6:VPP
P5 #	C3:CLK
P6 #	C7:I/O
P7 #	POL
P8 #	DET



RECOMMENDED PCB LAYOUT (TOP VIEW)
 GENERAL TOLERANCES: ±0.05
 SOLDER AREA
 NONE CIRCUIT DIAGRAM AREA



Finish:
 Contact: Gold Flash Plated On Contact Area; Gold Flash Plated On Solder Tails, With Entire Contact Underplated 50u" min Nickel.
 Shell: 50u" min Nickel Underplated Overall, Gold Flash Plated On Solder Tails.



Material:
 Housing: LCP, UL 94 V-0
 Contact: C5210R-H, T=0.15
 Shell: SUS304, T=0.20
 Mylar: Polyester.

GENERAL TOLERANCE		ANGLE TOLERANCE		PROJECTION		Description:	
X	±0.15	X	±5°	UNITS	mm	SIM CARD CONN; PUSH PUSH, 6P, H1.85mm, SMD with CD Pin L-KLS1-SIM-084-R.	
.X	±0.03	.X	±3°	SHEET SIZE	A4		
.XX	±0.05	.XX	±2°	KLS P/N:			
Draw by:	Jenny	Date:	2018-03-10	 NingBo KLS ELECTRONIC CO., L TD.			
Check by:		Date:	2018-03-10				
SCALE		SHEET	1 OF 1				